

RoHS Compliant Product

Description

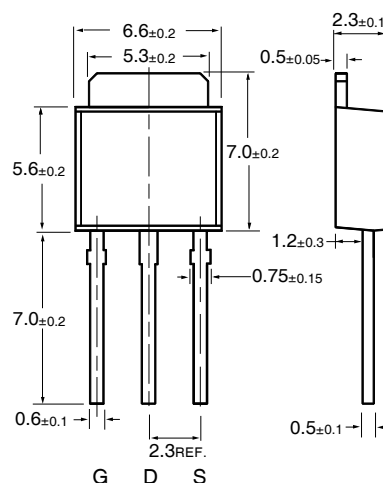
The SID9971 provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-251 is universally preferred for all commercial-industrial surface mount applications and suited for low voltage applications such as DC/DC converters.

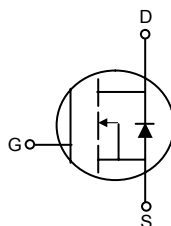
Features

- * Low On-Resistance
- * Simple Drive Requirement

TO-251



Dimensions in millimeters



Marking Code: 9971

XXXX(Date Code)

Absolute Maximum Ratings

Parameter	Symbol	Ratings	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current, $V_{GS}@10V$	$I_D@T_C=25^\circ C$	25	A
Continuous Drain Current, $V_{GS}@10V$	$I_D@T_C=100^\circ C$	16	A
Pulsed Drain Current ¹	I_{DM}	80	A
Total Power Dissipation	$P_D@T_C=25^\circ C$	39	W
Linear Derating Factor		0.31	W/ $^\circ C$
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55~+150	$^\circ C$

Thermal Data

Parameter	Symbol	Ratings	Unit
Thermal Resistance Junction-case	R_{thj-c}	3.2	$^\circ C/W$
Thermal Resistance Junction-ambient	R_{thj-a}	110	$^\circ C/W$

Electrical Characteristics($T_J=25^\circ\text{C}$ Unless otherwise specified)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Drain-Source Breakdown Voltage	BV_{DSS}	60	—	—	V	$V_{GS}=0V, I_D=250\mu A$
Breakdown Voltage Temp. Coefficient	$\Delta BV_{DS}/\Delta T_J$	—	0.05	—	V/ $^\circ\text{C}$	Reference to 25°C , $I_D=1\text{mA}$
Gate Threshold Voltage	$V_{GS(th)}$	1.0	—	3.0	V	$V_{DS}=V_{GS}, I_D=250\mu A$
Gate-Source Leakage Current	I_{GSS}	—	—	± 100	nA	$V_{GS}=\pm 20V$
Drain-Source Leakage Current ($T_J=25^\circ\text{C}$)	I_{DSS}	—	—	1	μA	$V_{DS}=60V, V_{GS}=0$
Drain-Source Leakage Current($T_J=150^\circ\text{C}$)		—	—	25	μA	$V_{DS}=48V, V_{GS}=0$
Static Drain-Source On-Resistance	$R_{DS(ON)}$	—	—	36	$\text{m}\Omega$	$V_{GS}=10V, I_D=18A$
		—	—	50		$V_{GS}=4.5V, I_D=12A$
Total Gate Charge ²	Q_g	—	18	30	nC	$I_D=18A$ $V_{DS}=48V$ $V_{GS}=4.5V$
Gate-Source Charge	Q_{gs}	—	6	—		
Gate-Drain ("Miller") Charge	Q_{gd}	—	11	—		
Turn-on Delay Time ²	$T_{d(ON)}$	—	9	—	nS	$V_{DD}=30V$ $I_D=18A$ $V_{GS}=10V$ $R_G=3.3\Omega$ $R_D=1.67\Omega$
Rise Time	T_r	—	24	—		
Turn-off Delay Time	$T_{d(OFF)}$	—	26	—		
Fall Time	T_f	—	7	—		
Input Capacitance	C_{iss}	—	1700	2700	pF	$V_{GS}=0V$ $V_{DS}=25V$ $f=1.0\text{MHz}$
Output Capacitance	C_{oss}	—	160	—		
Reverse Transfer Capacitance	C_{rss}	—	110	—		
Forward Transconductance	G_{fs}	—	17	—	S	$V_{DS}=10V, I_D=18A$

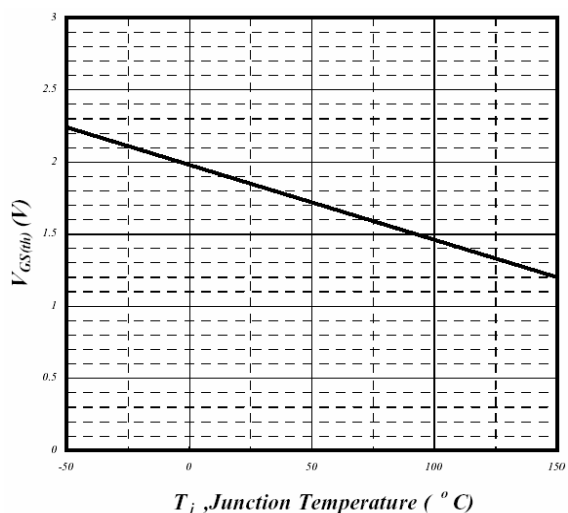
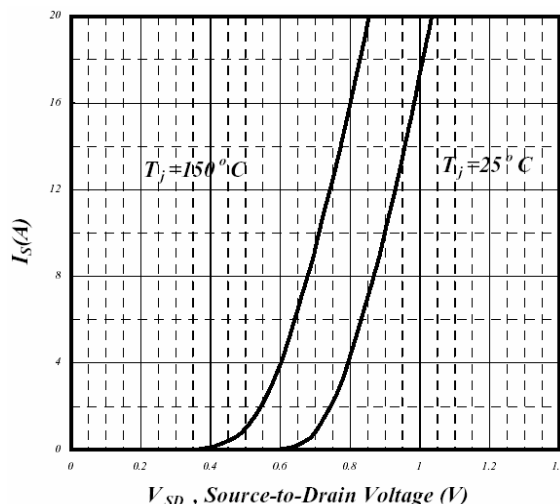
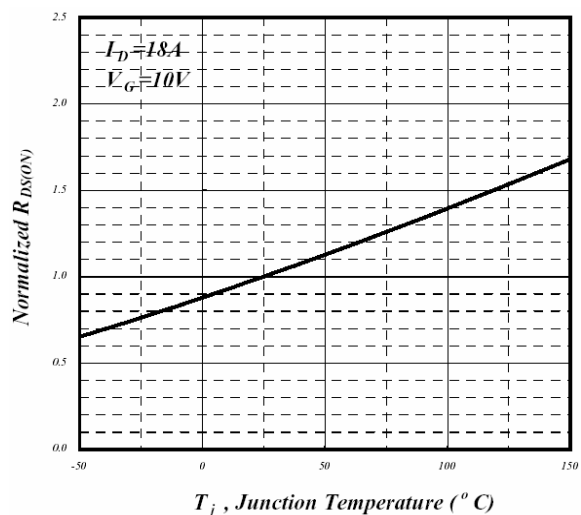
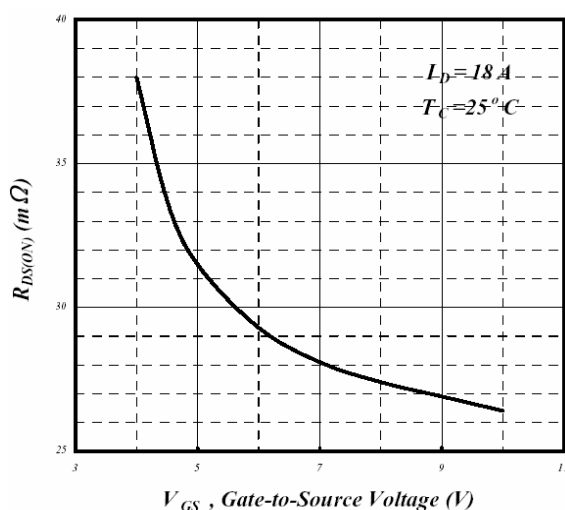
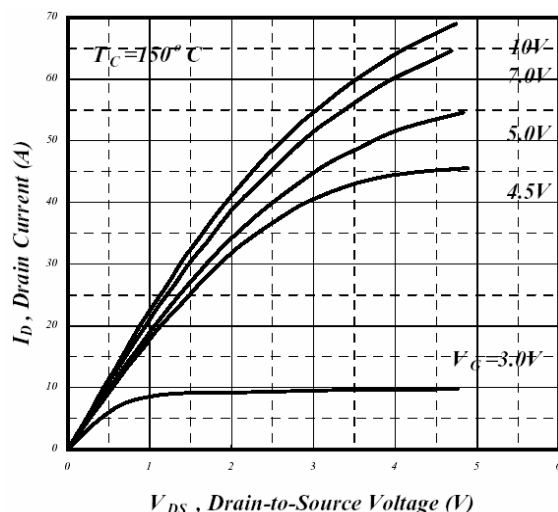
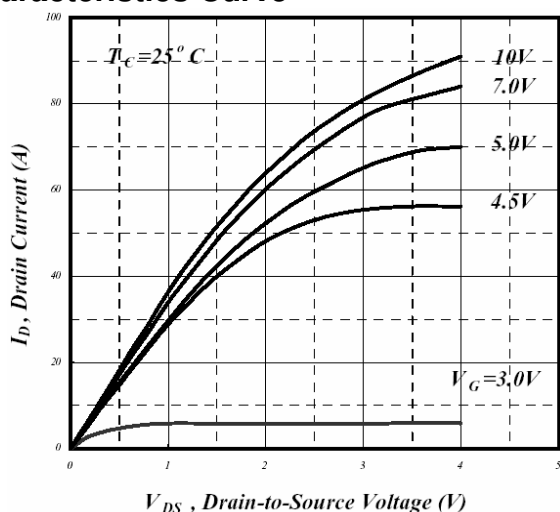
Source-Drain Diode

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Forward On Voltage ²	V_{SD}	—	—	1.2	V	$I_S=25\text{ A}, V_{GS}=0V.$
Reverse Recovery Time	T_{rr}	—	37	—	nS	$I_S=18A, V_{GS}=0V.$ $di/dt=100A/\mu s$
Reverse Recovery Charge	Q_{rr}	—	38	—	nC	

Notes: 1.Pulse width limited by safe operating area.

2.Pulse width $\leq 300\mu s$, dutycycle $\leq 2\%$.

Characteristics Curve



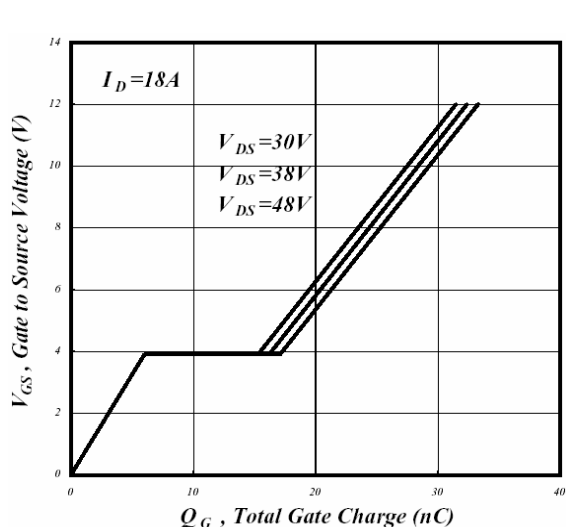


Fig 7. Gate Charge Characteristics

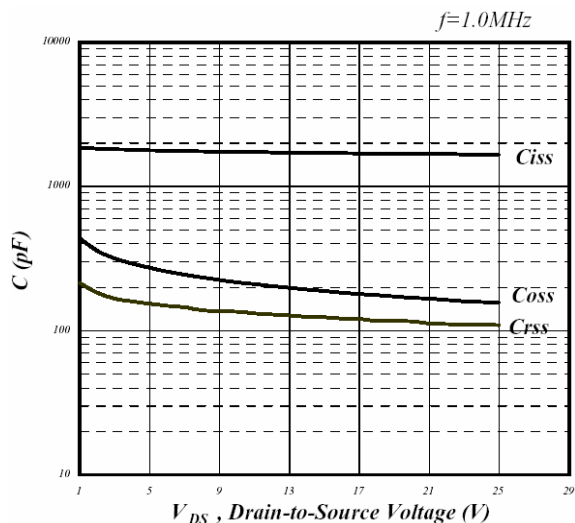


Fig 8. Typical Capacitance Characteristics

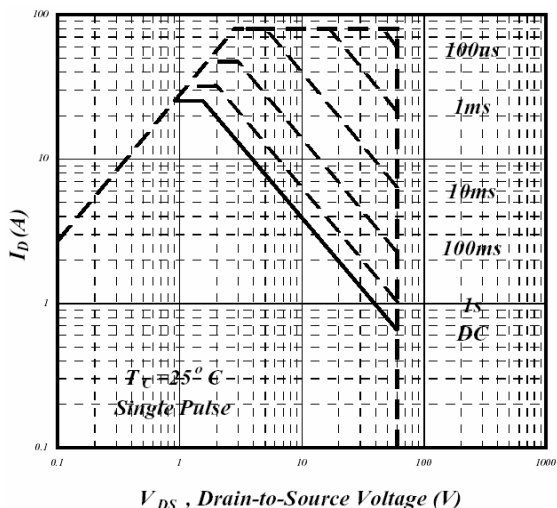


Fig 9. Maximum Safe Operating Area

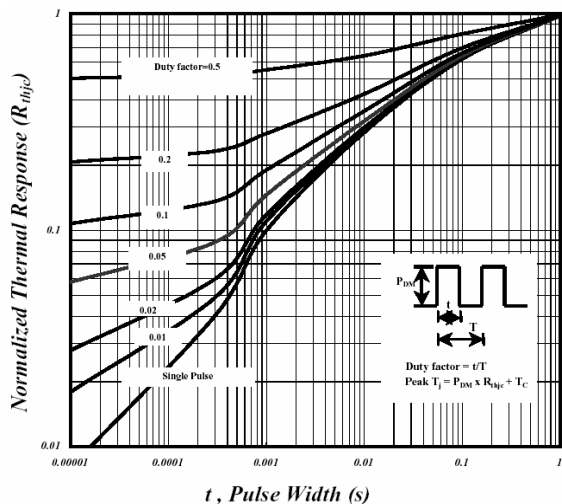


Fig 10. Effective Transient Thermal Impedance

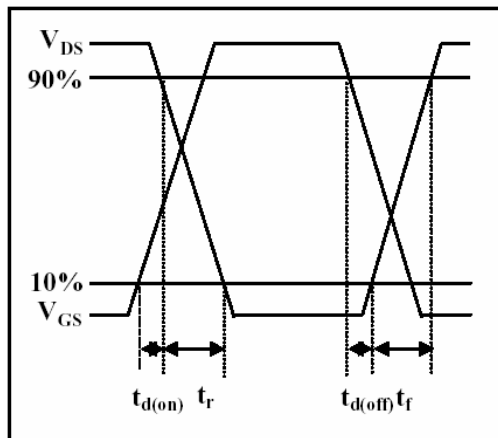


Fig 11. Switching Time Waveform

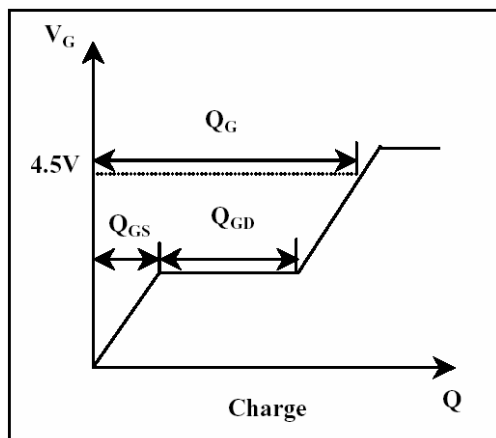


Fig 12. Gate Charge Waveform